

NTB5605PT4G-VB Datasheet P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY							
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ)				
- 60	0.064 at V _{GS} = - 10 V	- 30	10				
	0.077 at V _{GS} = - 4.5 V	- 28	12				

FEATURES

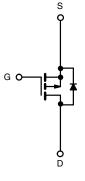
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested

APPLICATIONS

Load Switch







P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Gate-Source Voltage	V _{GS}	± 20	V		
Continuous Drain Current (T ₁ = 175 °C)	T _C = 25 °C	1_	- 30		
Continuous Drain Current (1) = 175 C)	T _C = 100 °C	I _D	- 20		
Pulsed Drain Current	I _{DM}	- 90	А		
Continuing Source Current (Diode Conduction)	۱ _S	- 28			
Avalanche Current	I _{AS}	- 31			
Single Pulse Avalanche Energy	E _{AS}	7.2	mJ		
Maximum Dawar Dissinction	T _C = 25 °C	Р	60 ^a	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	6 ^b		
Operating Junction and Storage Temperature Range	T _J , T _{stq}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
hunding to Ambient	$t \le 10 \text{ sec}$	R _{thJA}	20	25			
Junction-to-Ambient ^D	Steady State	' 'thJA	62	75	°C/W		
Junction-to-Case	R _{thJC}	5	6				

Notes:

a. See SOA curve for voltage derating.

b. Surface Mounted on 1" x 1" FR-4 boad.

SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit		
Static								
Drain-Source Breakdown Voltage V _{(E}		V_{GS} = 0 V, I_D = - 250 μ A	- 60			v		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1.0	- 2.0	- 3.0	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA		
		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1			
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μA		
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			- 150			
On-State Drain Current ^b	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 10			А		
		V _{GS} = - 10 V, I _D = - 5 A		0.064				
	r	V_{GS} = - 10 V, I_{D} = - 5 A, T_{J} = 125 °C		0.110				
Drain-Source On-State Resistance ^b	r _{DS(on)}	V_{GS} = - 10 V, I_D = - 5 A, T_J = 175 °C		0.250		Ω		
		V _{GS} = - 4.5 V, I _D = - 2 A		0.077		1		
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 15 V, I _D = - 5 A		8		S		
Dynamic	•	•		•	•	•		
Input Capacitance	C _{iss}			1000		pF		
Output Capacitance	C _{oss}	V_{DS} = - 25 V, V_{GS} = 0 V, f = 1 MHz		210				
Reverse Transfer Capacitance	C _{rss}			110		1		
Total Gate Charge	Qg			12.5	19	nC		
Gate-Source Charge	Q _{gs}	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -8.4$ A		2.3				
Gate-Drain Charge	Q _{gd}			3.2		1		
Gate Resistance	Rg	f = 1 MHz		8.0		Ω		
Turn-On Delay Time ^c	t _{d(on)}			5	10			
Rise Time ^c	t _r	V_{DD} = - 30 V, R_L = 3.57 Ω		14	25]		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 8.4 A, V_{GEN} = - 10 V, R_G = 2.5 Ω		15	25	- ns		
Fall Time ^c	t _f			7	12			
Source-Drain Diode Ratings and Characteristics $(T_C = 25 \ ^{\circ}C)^b$								
Pulsed Current	I _{SM}				- 30	А		
Forward Voltage ^b	V _{SD}	I _F = - 2 A, V _{GS} = 0 V		- 0.9	- 1.3	V		
Reverse Recovery Time	t _{rr}	I _F = - 8 A, di/dt = 100 A/μs		50	80	ns		
Reverse Recovery Time	Q _{rr}	$r_{\rm F} = -0.7$, $u/u_{\rm F} = -0.7$, $u/\mu_{\rm S}$		80	120	nC		

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

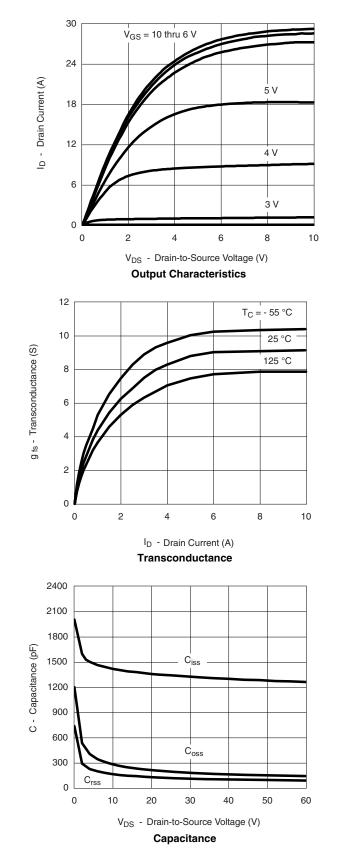
c. Independent of operating temperature.

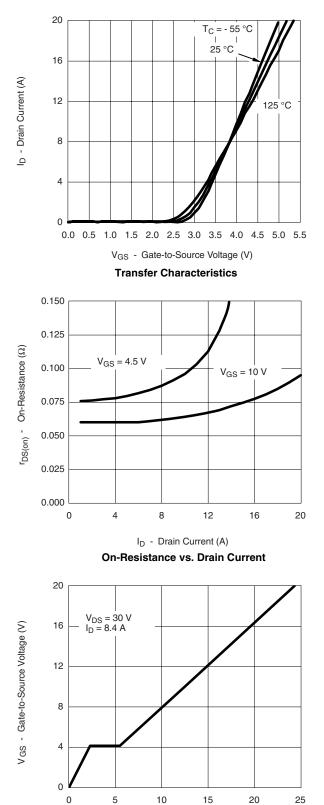
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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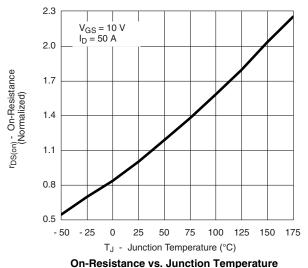


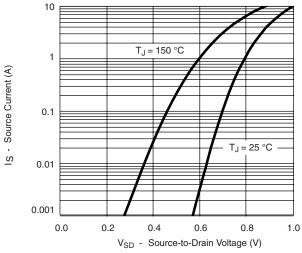
TYPICAL CHARACTERISTICS 25 °C unless noted





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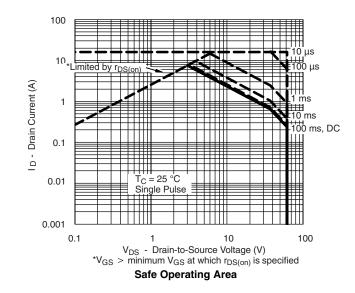




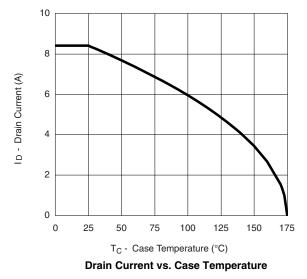
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Source-Drain Diode Forward Voltage

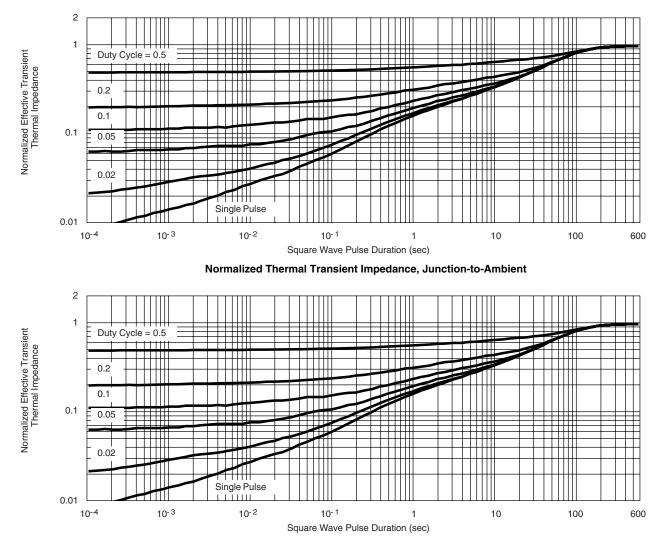


THERMAL RATINGS





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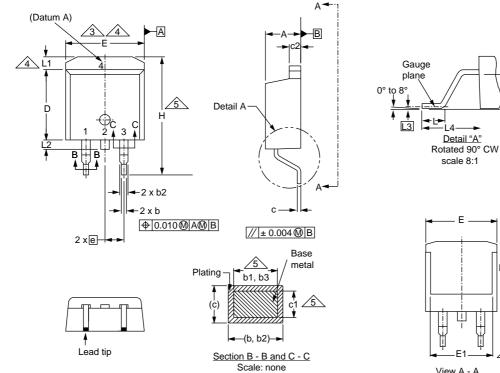


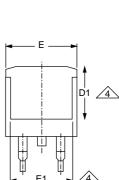
Normalized Thermal Transient Impedance, Junction-to-Case

NTB5605PT4G-VB



TO-263AB





Detail "A"

scale 8:1

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B

A1

Seating plane

1	V	iew	А	-	A

	MILLIMETERS		INCHES			MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MAX
А	4.06	4.83	0.160	0.190	D1	6.86	-	0.270	-
A1	0.00	0.25	0.000	0.010	E	9.65	10.67	0.380	0.42
b	0.51	0.99	0.020	0.039	E1	6.22	-	0.245	-
b1	0.51	0.89	0.020	0.035	е	2.54 BSC		0.100 BSC	
b2	1.14	1.78	0.045	0.070	Н	14.61	15.88	0.575	0.62
b3	1.14	1.73	0.045	0.068	L	1.78	2.79	0.070	0.11
С	0.38	0.74	0.015	0.029	L1	-	1.65	-	0.06
c1	0.38	0.58	0.015	0.023	L2	-	1.78	-	0.07
c2	1.14	1.65	0.045	0.065	L3	0.25 BSC		0.010 BSC	
D	8.38	9.65	0.330	0.380	L4	4.78	5.28	0.188	0.20
ECN: S-82 DWG: 597	2110-Rev. A, 0	15-Sep-08	•	1		-		•	•
lotos									

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

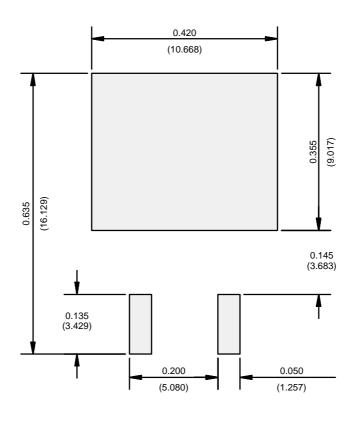
5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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